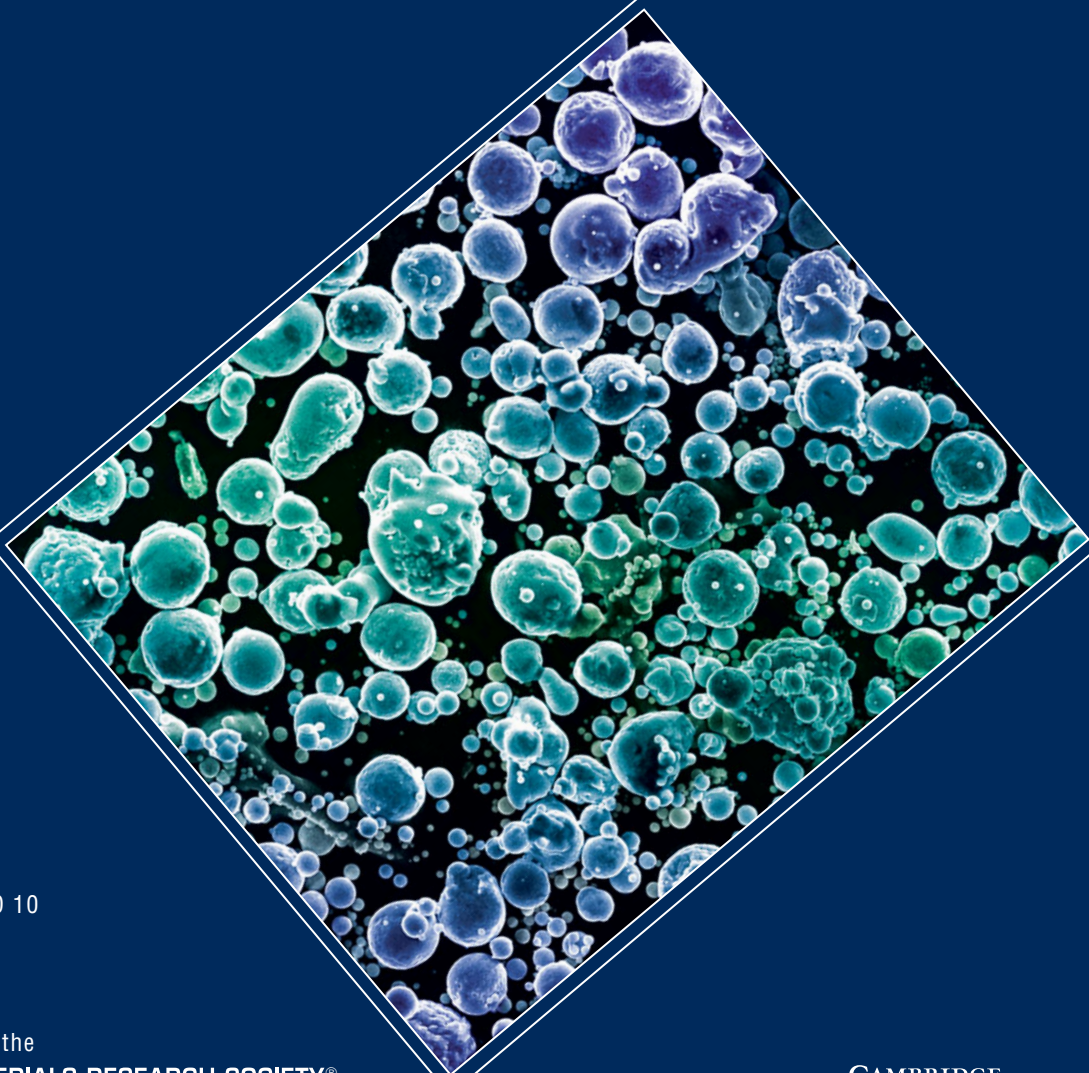


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Cover: FIG. 1. (a) Particle morphology of the starting AA8009 alloy powder. [S. Sun, L. Zheng, Y. Liu, J. Liu, and H. Zhang: Characterization of Al-Fe-V-Si heat-resistant aluminum alloy components fabricated by selective laser melting. p. 1661].

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